# FAIRCHILD

SEMICONDUCTOR TM

# FQD7N10L / FQU7N10L 100V LOGIC N-Channel MOSFET

### **General Description**

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology is especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation modes. These devices are well suited for low voltage applications such as high efficiency switching DC/DC converters, and DC motor control.

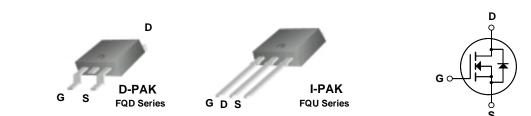
### Features

- 5.8A, 100V,  $R_{DS(on)} = 0.35\Omega @V_{GS} = 10 V$
- Low gate charge (typical 4.6 nC)
- Low Crss (typical 12 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- Low level gate drive requirments allowing direct operation from logic drives
- RoHS Compliant



October 2008

**OFE** 



## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		FQD7N10L / FQU7N10L	Units
V <sub>DSS</sub>	Drain-Source Voltage		100	V
I <sub>D</sub>	Drain Current - Continuous ( $T_C = 25^{\circ}C$ )		5.8	А
	- Continuous (T <sub>C</sub> = 100°C)		3.67	А
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	23.2	А
V <sub>GSS</sub>	Gate-Source Voltage		± 20	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	50	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	5.8	А
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	2.5	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.0	V/ns
P <sub>D</sub>	Power Dissipation ( $T_A = 25^{\circ}C$ ) *		2.5	W
	Power Dissipation ( $T_C = 25^{\circ}C$ )		25	W
	- Derate above 25°C		0.2	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

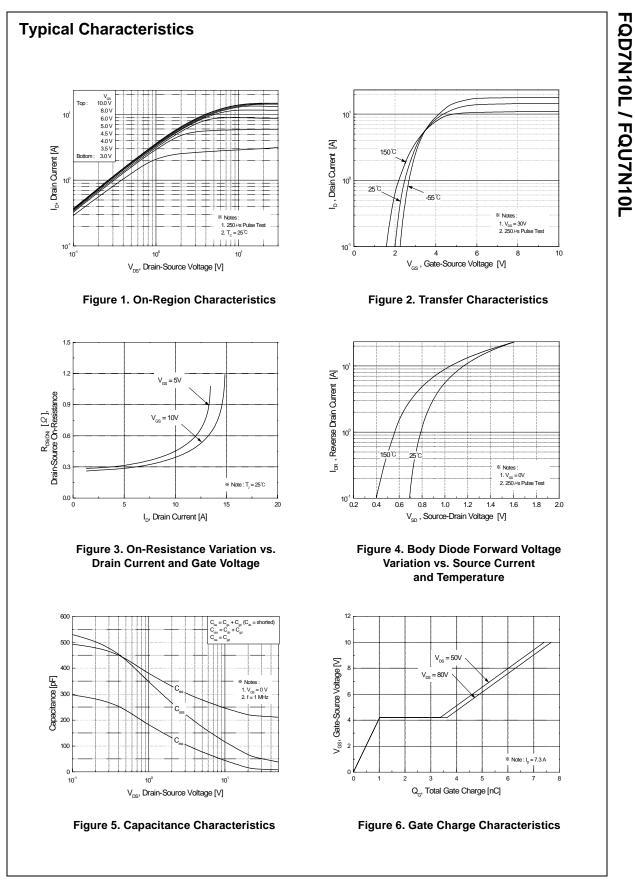
## **Thermal Characteristics**

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		5.0	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		110	°C/W

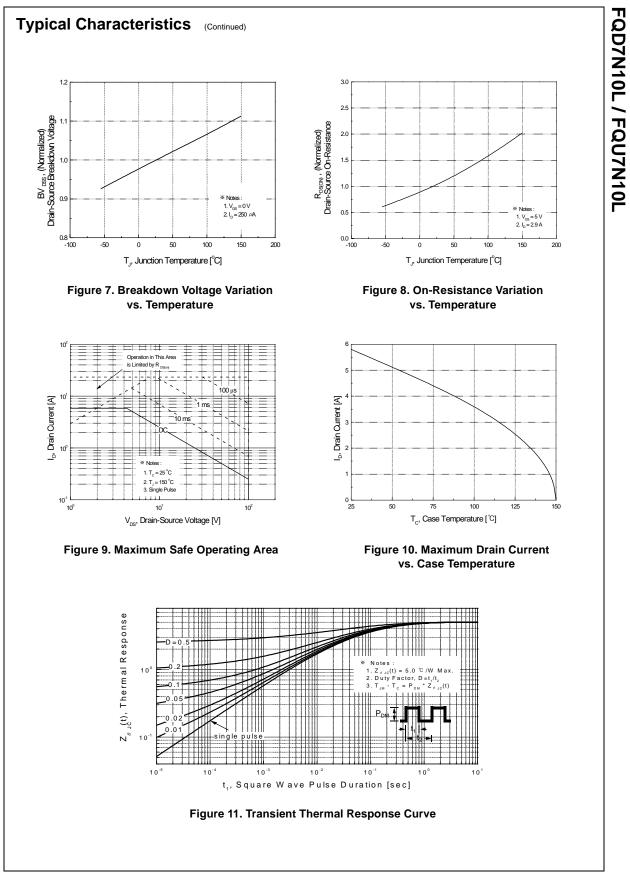
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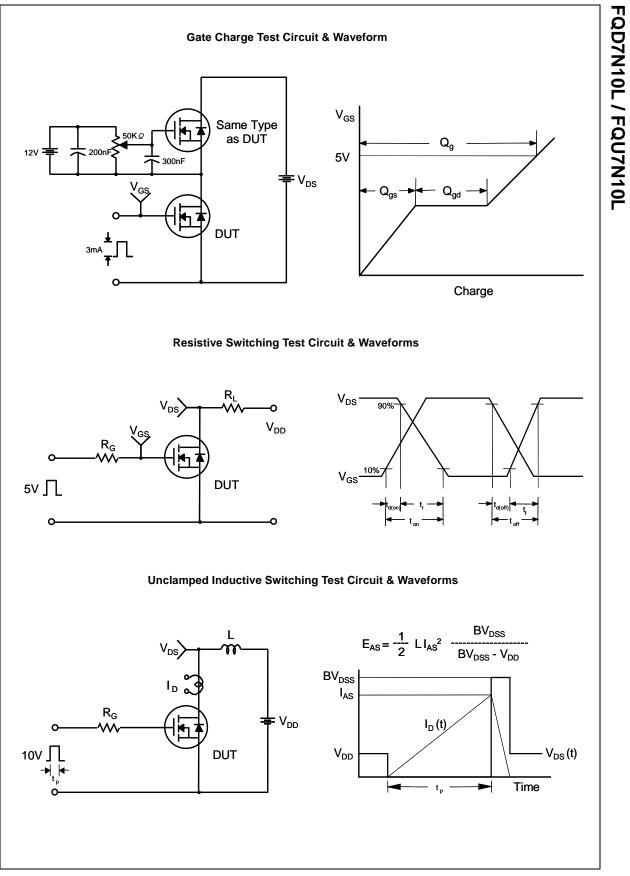
	Parameter	Test Conditions	6	Min	Тур	Max	Units
	racteristics						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		100			V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu$ A, Referenced	to 25°C		0.1		V/°C
DSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V				1	μA
	Zero Gate voltage Drain Current	$V_{DS} = 80 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$				10	μΑ
GSSF	Gate-Body Leakage Current, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
On Cha	racteristics						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		1.0		2.0	V
R <sub>DS(on)</sub>	Static Drain-Source	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.9 \text{ A}$			0.275	0.35	•
.DS(on)	On-Resistance	$V_{GS} = 5 V, I_D = 2.9 A$			0.275	0.35	Ω
Ĵfs	Forward Transconductance	$V_{DS} = 30 \text{ V}, \text{ I}_{D} = 2.9 \text{ A}$	(Note 4)		4.6		S
-							
-	c Characteristics				000	000	
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 25 V, V_{GS} = 0 V,$ f = 1.0 MHz			220	290	pF
C <sub>oss</sub>	Output Capacitance				55	72	pF
C <sub>rss</sub>	Reverse Transfer Capacitance				12	15	pF
Switchi	ng Characteristics						
d(on)	Turn-On Delay Time	V = 50 V = 72 A			9	30	ns
r	Turn-On Rise Time	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 7.3 \text{ A},$ R <sub>G</sub> = 25 $\Omega$			100	210	ns
d(off)	Turn-Off Delay Time	- KG - 23 32			17	45	ns
f	Turn-Off Fall Time	-	(Note 4, 5)		50	110	ns
ე <sup>g</sup>	Total Gate Charge	V <sub>DS</sub> = 80 V, I <sub>D</sub> = 7.3 A,			4.6	6.0	nC
ຊ <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 5 V$			1.0		nC
ຊ <sub>gd</sub>	Gate-Drain Charge		(Note 4, 5)		2.6		nC
1	ource Diode Characteristics ar Maximum Continuous Drain-Source Dio		S			5.0	Δ
S						5.8	A
SM	Maximum Pulsed Drain-Source Diode F	$V_{GS} = 0 V, I_S = 5.8 A$				23.2	A
√ <sub>SD</sub>						1.5	V
rr	Reverse Recovery Time Reverse Recovery Charge	$V_{GS} = 0 V, I_S = 7.3 A,$ $dI_F / dt = 100 A/\mu s$	(Note 4)		70 140		ns nC
Q <sub>rr</sub>	Reverse Recovery Charge		(11010 4)		140		no

FQD7N10L / FQU7N10L

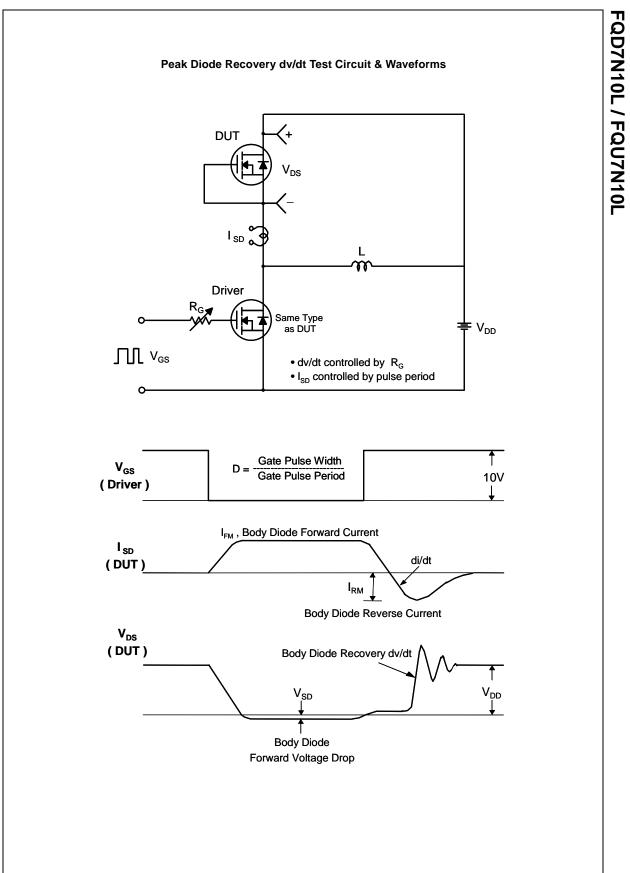


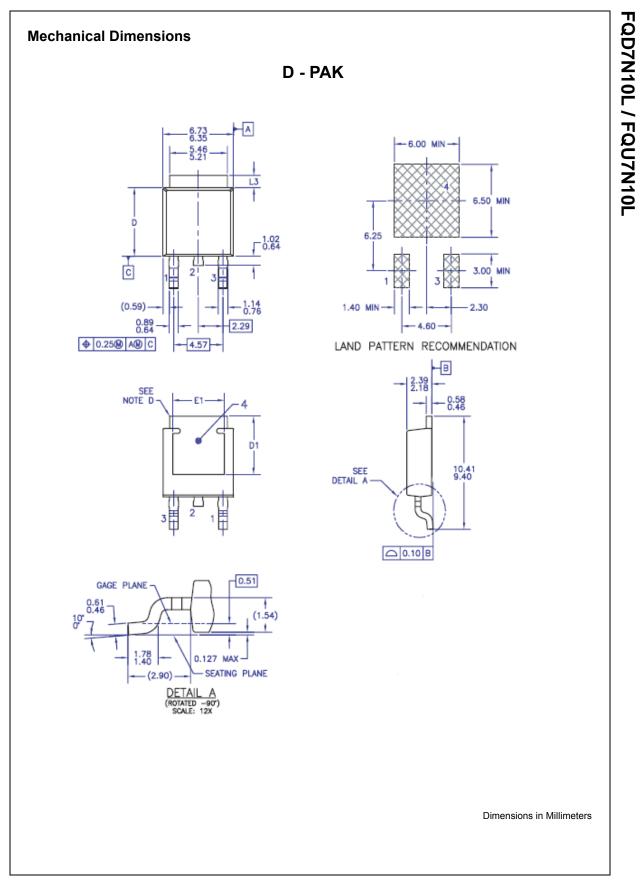
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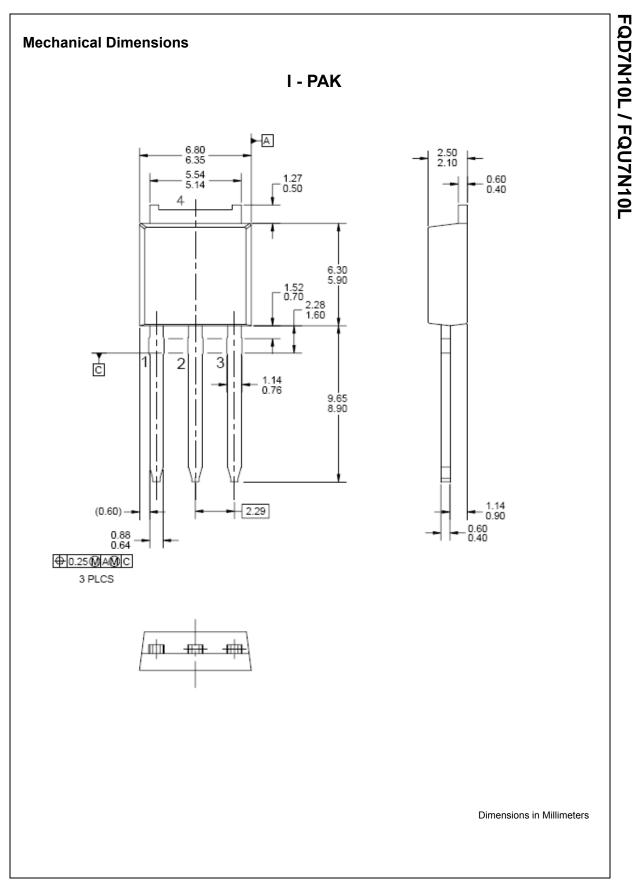




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